

Sample &

Buy





UC1846, UC1847, UC2846 UC2847, UC3846, UC3847

SLUS352C – JANUARY 1997 – REVISED DECEMBER 2015

UCx846/7 Current Mode PWM Controller

Technical

Documents

Features 1

- Automatic Feedforward Compensation
- Programmable Pulse-by-Pulse Current Limiting
- Automatic Symmetry Correction in Push-Pull Configuration
- **Enhanced Load Response Characteristics**
- Parallel Operation Capability for Modular Power Systems
- Differential Current Sense Amplifier with Wide Common Mode Range
- **Double-Pulse Suppression**
- 500-mA (Peak) Totem-pole Outputs
- ±1% Band Gap Reference
- Undervoltage Lockout
- Soft-Start Capability
- Shutdown Terminal
- 500-kHz Operation

Applications 2

- **Telecommunication Power Converters**
- Industrial Power Converters

3 Description

Tools &

Software

The UC1846/7 family of control devices provides all of the necessary features to implement fixedfrequency, current-mode control schemes while maintaining a minimum external parts count. The superior performance of this technique can be measured in improved line regulation, enhanced load response characteristics, and a simpler, easier-todesign control loop. Topological advantages include inherent pulse-by-pulse current limiting capability, symmetry automatic correction for push-pull converters, and the ability to parallel power modules while maintaining equal current sharing.

Protection circuitry includes built-in undervoltage lockout and programmable current limit, in addition to soft-start capability. A shutdown function is also available, which can initiate either a complete shutdown with automatic restart or latch the supply off.

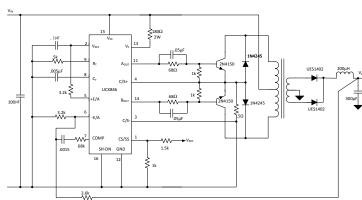
Other features include fully-latched operation, doublepulse suppression, deadline adjust capability, and a ±1% trimmed band gap reference.

The UC1846 features low outputs in the OFF state, while the UCx847 features high outputs in the OFF state.

| Device Information(" | | | | | | |
|----------------------|-----------|--------------------|--|--|--|--|
| PART NUMBER | PACKAGE | BODY SIZE (NOM) | | | | |
| UC1846 | LCCC (20) | 8.89 mm × 8.89 mm | | | | |
| | CDIP (16) | 6.92 mm × 19.56 mm | | | | |
| | PLCC (20) | 8.96 mm × 8.96 mm | | | | |
| UC2846, UC3846 | SOIC (16) | 7.5 mm × 10.3 mm | | | | |
| | PDIP (16) | 6.35 mm × 19.3 mm | | | | |
| | SOIC (16) | 7.5 mm × 10.3 mm | | | | |
| UC2847, UC3847 | PDIP (16) | 6.35 mm × 19.3 mm | | | | |

(1)

(1) For all available packages, see the orderable addendum at the end of the datasheet.



Block Diagram



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4 Revision History

2

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision B (July 2010) to Revision C

| Ch | from Revision A (February 2002) to Revision B Pag | е |
|----|--|---|
| • | ved soldering temperature | 4 |
| | ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation n, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and anical, Packaging, and Orderable Information section. | |
| | | |

| • | Updated Block Diagram | 1 |
|---|-----------------------|---|

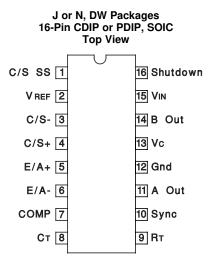


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Page



5 Pin Configuration and Functions



FN or FK Packages 20-Pin PLCC or LCCC Top View

| _ | 3 | 2 | 1 | 20 | 19 | |
|----|---|----|-----------|----|----|----|
| 4 | | | \cup | | | 18 |
| 5 | | | | | | 17 |
| 6 | | | | | | 16 |
| (7 | | | | | | 15 |
| 8 | ~ | 40 | | 40 | | 14 |
| | 9 | 10 | <u>11</u> | 12 | 13 | |

Pin Functions

| PIN | | | | | | |
|---------------|------------------|------------------|-----|---|--|--|
| DIL, SOIC NO. | PLCC, LCC NO. | NAME | I/O | DESCRIPTION | | |
| 1 | 2 | C/S SS | - | Current limit/soft-start programming | | |
| 2 | 3 | V _{REF} | 0 | 5.1-V reference voltage output | | |
| 3 | 4 | C/S – | I | Current sense comparator inverting input | | |
| 4 | 5 | C/S + | - | Current sense comparator non-inverting input | | |
| 5 | 7 | E/A + | - | Error amplifier inverting input | | |
| 6 | 8 | E/A – | - | Error amplifier inverting input | | |
| 7 | 9 | COMP | I/O | Error amplifier output and input to the PWM comparator | | |
| 8 | 10 | CT | - | Oscillator frequency programming capacitor pin | | |
| 9 | 12 | C _R | | Oscillator frequency programming resistor pin | | |
| 10 | 13 | Sync | I/O | Synchronization out from master controller or input of slave controller | | |
| 11 | 14 | A Out | 0 | PWM drive signal output A, Pin11 and P14 are complementary | | |
| 12 | 15 | GND | G | All signals are referenced to this node | | |
| 13 | 17 | V _C | - | Bias supply input for output stage | | |
| 14 | 18 | B Out | 0 | PWM drive signal output B, Pin11 and P14 are complementary | | |
| 15 | 19 | V _{IN} | I | Bias supply input | | |
| 16 | 20 | Shutdown | | External shutdown signal input | | |
| _ | 1, 6, 11, 16 | N/C | | | | |

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6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | MIN | МАХ | UNIT |
|--|------|------------------|------|
| Supply Voltage (Pin 15) | | 40 | V |
| Collector Supply Voltage (Pin 13) | | 40 | V |
| Output Current, Source or Sink (Pins 11, 14) | | 500 | mA |
| Analog Inputs (Pins 3, 4, 5, 6, 16) | -0.3 | +V _{IN} | V |
| Reference Output Current (Pin 2) | | -30 | mA |
| Sync Output Current (Pin 10) | | -5 | mA |
| Error Amplifier Output Current (Pin 7) | | -5 | mA |
| Soft Start Sink Current (Pin 1) | | 50 | mA |
| Oscillator Charging Current (Pin 9) | | 5 | mA |
| Power Dissipation at $T_A = 25^{\circ}C$ | | 1000 | mW |
| Power Dissipation at $T_{C} = 25^{\circ}C$ | | 2000 | mW |
| Storage temperature, T _{stg} | -65 | 150 | °C |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

| | | | VALUE | UNIT |
|-------------|-------------------------|---|-------|------|
| | | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | ±2500 | |
| $V_{(ESD)}$ | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 $^{\left(2\right) }$ | ±1500 | V |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | MIN | NOM | MAX | UNIT |
|------------------------------------|-----|-----|-----|------|
| VREF terminal external capacitance | 1 | | 2.2 | μF |

6.4 Thermal Information

| | SOIC) 16 PINS Junction-to-ambient thermal resistance 41.8 Junction-to-case (top) thermal resistance 28.5 | 846/7 | | |
|-----------------------|--|---------|---------------------------|------|
| | THERMAL METRIC ⁽¹⁾ | • | J or DW (CDIP or SOIC) | UNIT |
| | | 16 PINS | 16 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 41.8 | 73.1 | °C/W |
| R _{0JC(top)} | Junction-to-case (top) thermal resistance | 28.5 | 34.2 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 21.8 | 38.0 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 13.0 | 7.7 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 21.7 | 37.4 | °C/W |
| R _{0JC(bot)} | Junction-to-case (bottom) thermal resistance | N/A | N/A | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, SPRA953.

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6.5 Electrical Characteristics

 $T_{A}=-55^{\circ}C \text{ to } +125^{\circ}C \text{ for UC1846/7}; -40^{\circ}C \text{ to } +85^{\circ}C \text{ for the UC2846/7}; \text{ and } 0^{\circ}C \text{ to } +70^{\circ}C \text{ for the UC3846/7}; V_{IN}=15 \text{ V}, R_{T}=10 \text{ k}, C_{T}=4.7 \text{ nF}, T_{A}=T_{J} \text{ (unless otherwise noted)}$

| PARAMETER | TEST CONDITIONS | | C1846/7 C2846/7 | | U | C3846/7 | | UNIT |
|------------------------------|---|------|--------------------|-----------------------|------|---------|-----------------------|-------|
| | | MIN | ТҮР | МАХ | MIN | ТҮР | MAX | |
| REFERENCE | | | | | | | | |
| Output Voltage | $T_{J} = 25^{\circ}C, I_{O} = 1 \text{ mA}$ | 5.05 | 5.10 | 5.15 | 5.00 | 5.10 | 5.20 | V |
| Line Regulation | V _{IN} = 8 V to 40 V | | 5 | 20 | | 5 | 20 | mV |
| Load Regulation | $I_L = 1 \text{ mA to } 10 \text{ mA}$ | | 3 | 15 | | 3 | 15 | mV |
| Temperature Stability | Over Operating Range, ⁽¹⁾ | | 0.4 | | | 0.4 | | mV/°C |
| Total Output Variation | Line, Load, and Temperature ⁽¹⁾ | 5.00 | | 5.20 | 4.95 | | 5.25 | V |
| Output Noise Voltage | 10 Hz ≤ f ≤10 kHz, T _J = 25°C ⁽¹⁾ | | 100 | | | 100 | | μV |
| Long Term Stability | T _J = 125°C, 1000 Hrs ⁽¹⁾ | | 5 | | | 5 | | mV |
| Short Circuit Output Current | V _{REF} = 0 V | -10 | -45 | | -10 | -45 | | mA |
| OSCILLATOR | | | | | | | | |
| Initial Accuracy | $T_J = 25^{\circ}C$ | 39 | 43 | 47 | 39 | 43 | 47 | kHz |
| Voltage Stability | V _{IN} =8 V to 40 V | | -1% | 2% | | -1% | 2% | |
| Temperature Stability | Over Operating Range ⁽¹⁾ | | -1% | | | -1% | | |
| Sync Output High Level | | 3.9 | 4.35 | | 3.9 | 4.35 | | V |
| Sync Output Low Level | | | 2.3 | 2.5 | | 2.3 | 2.5 | V |
| Sync Input High Level | Pin 8 = 0 V | 3.9 | | | 3.9 | | | V |
| Sync Input Low Level | Pin 8 = 0 V | | | 2.5 | | | 2.5 | V |
| Sync Input Current | Sync Voltage = 3.9 V, Pin 8 = 0 V | | 1.3 | 1.5 | | 1.3 | 1.5 | mA |
| ERROR AMPLIFIER | | | | | | | | |
| Input Offset Voltage | | | 0.5 | 5 | | 0.5 | 10 | mV |
| Input Bias Current | | | -0.6 | -1 | | -0.6 | -2 | μA |
| Input Offset Current | | | 40 | 250 | | 40 | 250 | nA |
| Common Mode Range | $V_{IN} = 8 V$ to 40 V | 0 | | V _{IN} - 2 V | 0 | | V _{IN} - 2 V | V |
| Open Loop Voltage Gain | $\Delta V_{O} = 1.2$ to 3 V, V _{CM} = 2 V | 80 | 105 | | 80 | 105 | | dB |
| Unity Gain Bandwidth | $T_{\rm J} = 25^{\circ}C^{(1)}$ | 0.7 | 1.0 | | 0.7 | 1.0 | | MHz |
| CMRR | | 75 | 100 | | 75 | 100 | | dB |
| PSRR | V _{IN} = 8 V to 40 V | 80 | 105 | | 80 | 105 | | dB |
| Output Sink Current | $V_{ID} = -15 \text{ mV to } -5 \text{ V},$ $V_{PIN7} = 1.2 \text{ V}$ | 2 | 6 | | 2 | 6 | | mA |
| Output Source Current | $V_{ID} = 15 \text{ mV to } -5 \text{ V},$ $V_{PIN7} = 2.5 \text{ V}$ | -0.4 | -0.5 | | -0.4 | -0.5 | | mA |
| High Level Output Voltage | R _L = (Pin 7) 15 kΩ | 4.3 | 4.6 | | 4.3 | 4.6 | | V |
| Low Level Output Voltage | R _L = (Pin 7) 15 kΩ | | 0.7 | 1 | | 0.7 | 1 | V |
| CURRENT SENSE AMPLIFIE | R | | | i | | | | |
| Amplifier Gain | $V_{PIN 3} = 0 V, Pin 1$ Open ⁽²⁾ , ⁽³⁾ | 2.5 | 2.75 | 3.0 | 2.5 | 2.75 | 3.0 | V |

(1) These parameters, although ensured over the recommended operating conditions, are not 100% tested in production.

(2) Parameter measured at trip point of latch with VPIN 5 = VREF, VPIN 6 = 0 V.

(3) Amplifier gain defined as: $G = \Delta V_{PIN7} / \Delta V_{PIN4}$; $V_{PIN4} = 0$ to 1.0 V



Electrical Characteristics (continued)

 $T_{A}=-55^{\circ}C \text{ to }+125^{\circ}C \text{ for UC1846/7; }-40^{\circ}C \text{ to }+85^{\circ}C \text{ for the UC2846/7; and }0^{\circ}C \text{ to }+70^{\circ}C \text{ for the UC3846/7; }V_{IN}=15 \text{ V, }R_{T}=10 \text{ k, }C_{T}=4.7 \text{ nF, }T_{A}=T_{J} \text{ (unless otherwise noted)}$

| PARAMETER | TEST CONDITIONS | | C1846/7 C2846/7 | | UC3846/7 | | | | |
|--|--|--------------------|--------------------|--------------------|----------|------|--------------------|----|--|
| | | MIN | ТҮР | MAX | MIN | ТҮР | MAX | | |
| Maximum Differential Input Signal (V _{PIN 4} -V _{PIN 3}) | Pin 1 Open ⁽²⁾ ; R _L (Pin 7) = 15 kW | 1.1 | 1.2 | | 1.1 | 1.2 | | V | |
| Input Offset Voltage | $V_{PIN 1} = 0.5 V, Pin 7 Open^{(2)}$ | | 5 | 25 | | 5 | 25 | mV | |
| CMRR | V _{CM} = 1 V to 12 V | 60 | 83 | | 60 | 83 | | dB | |
| PSRR | $V_{IN} = 8 V \text{ to } 40 V$ | 60 | 84 | | 60 | 84 | | dB | |
| Input Bias Current | $V_{\text{PIN 1}} = 0.5 \text{ V}, \text{ Pin 7}$ Open ⁽²⁾ | | -2.5 | -10 | | -2.5 | -10 | μA | |
| Input Offset Current | $V_{\text{PIN 1}} = 0.5 \text{ V}, \text{ Pin 7}$ Open ⁽²⁾ | | 0.08 | 1 | | 0.08 | 1 | μA | |
| Input Common Mode Range | | 0 | | V _{IN} -3 | 0 | | V _{IN} -3 | V | |
| Delay to Outputs | $T_{\rm J} = 25^{\circ}C^{(1)}$ | | 200 | 500 | | 200 | 500 | ns | |
| CURRENT LIMIT ADJUST | | | | | | | | | |
| Current Limit Offset | $V_{PIN 3} = 0 V, V_{PIN 4} = 0 V, Pin 7 Open^{(2)}$ | 0.45 | 0.5 | 0.55 | 0.45 | 0.5 | 0.55 | V | |
| Input Bias Current | $V_{PIN 5} = V_{REF}, V_{PIN 6}$ $= 0 V$ | | -10 | -30 | | -10 | -30 | μA | |
| SHUTDOWN TERMINAL | | | | | | | | | |
| Threshold Voltage | | 250 | 350 | 400 | 250 | 350 | 400 | mV | |
| Input Voltage Range | | 0 | | V _{IN} | 0 | | V _{IN} | V | |
| Minimum Latching Current (I _{PIN1}) | | ⁽⁴⁾ 3.0 | 1.5 | | 3.0 | 1.5 | | mA | |
| Maximum Latching Current (I _{PIN1}) | | | ⁽⁵⁾ 1.5 | 0.8 | | 1.5 | 0.8 | mA | |
| Delay to Outputs | $T_J = 25^{\circ}C^{(1)}$ | | 300 | 600 | | 300 | 600 | ns | |
| OUTPUT | | | | | | | | | |
| Collector-Emitter Voltage | | 40 | | | 40 | | | V | |
| Collector Leakage Current | $V_{\rm C} = 40 \ V^{(6)}$ | | | 200 | | | 200 | μA | |
| Output Low Loval | I _{SINK} = 20 mA | | 0.1 | 0.4 | | 0.1 | 0.4 | v | |
| Output Low Level | I _{SINK} = 100 mA | | 0.4 | 2.1 | | 0.4 | 2.1 | v | |
| Output Lligh Loval | I _{SOURCE} = 20 mA | 13 | 13.5 | | 13 | 13.5 | | V | |
| Output High Level | I _{SOURCE} = 100 mA | 12 | 13.5 | | 12 | 13.5 | | V | |
| Rise Time | $C_{L} = 1 \text{ nF}, T_{J} = 25^{\circ}C$ | | 50 | 300 | | 50 | 300 | ns | |
| Fall Time | $C_{L} = 1 \text{ nF}, T_{J} = 25^{\circ}C$ | | 50 | 300 | | 50 | 300 | ns | |
| UNDERVOLTAGE LOCKOUT | T I | | | | | | | | |
| Start-Up Threshold | | | 7.7 | 8.0 | | 7.7 | 8.0 | V | |
| Threshold Hysteresis | | | 0.75 | | | 0.75 | | V | |
| TOTAL STANDBY CURRENT | Г | | | | | | | | |
| Supply Current | | | 17 | 21 | | 17 | 21 | mA | |

(4) Current into Pin 1 ensured to latch circuit in shutdown state.

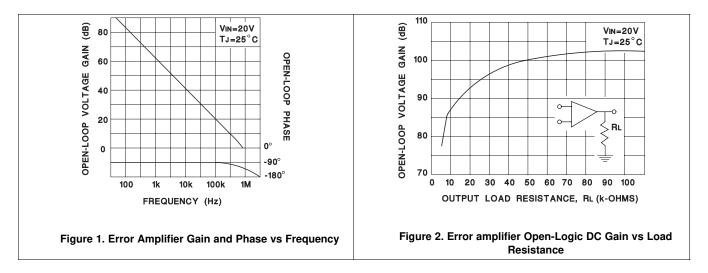
(5) Current into Pin 1 ensured not to latch circuit in shutdown state.

(6) Applies to UC1846/UC2846/UC3846 only due to polarity of outputs.



7

6.6 Typical Characteristics



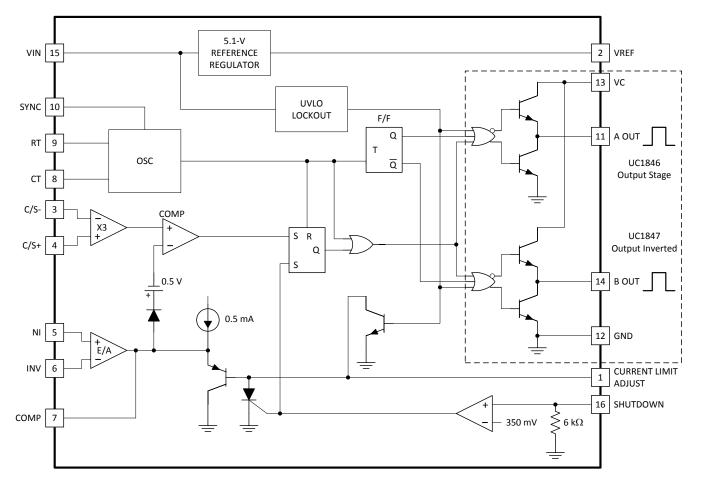
TEXAS INSTRUMENTS

7 Detailed Description

7.1 Overview

The UCx846/7 family of control devices provides the necessary features to implement off-line or DC-to-DC fixedfrequency, current-mode control schemes with a minimal external parts count. Internally implemented circuits include under-voltage lockout featuring start-up current less than 1 mA, a precision reference trimmed for accuracy at the error amplifier input, logic to insure latched operation, a PWM comparator which also provides current limit control, and a totem pole output stage designed to source or sink high-peak current. The output stage, suitable for driving either N-Channel MOSFETs or bipolar transistor switches, is low in the off state.

7.2 Functional Block Diagram



7.3 Feature Description

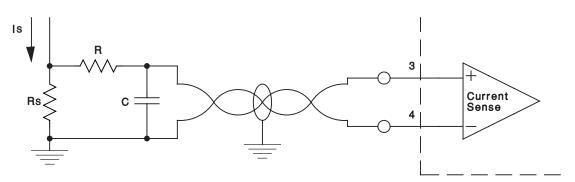
7.3.1 Current Sense Amplifier

The current sense amplifier may be used in a variety of ways to sense peak switch current for comparison with an error voltage. Referring to *Functional Block Diagram*, maximum swing on the inverting input of the PWM comparator is limited to approximately 3.5 V by the internal regulated supply. Accordingly, for a fixed gain of 3, maximum differential voltages must be kept below 1.2 V at the current sense inputs.

8



Feature Description (continued)



A small RC filter may be required in some applications to reduce switch transients. Differential input allows remote, noise free sensing.

Figure 3. Current Sense Amplifier Connection

7.3.2 Oscillator

By implementing the oscillator using all NPN transistors, the UCx846/7 achieves excellent temperature stability and waveform clarity at frequencies in excess of 1 MHz.

Referring to Figure 4, an external resistor R_T is used to generate a constant current into a capacitor C_T to produce a linear sawtooth waveform. Oscillator frequency may be approximated by selecting R_T and C_T such that:

$$f_{OSC} = \frac{2.2}{R_T C_T}$$
(1)

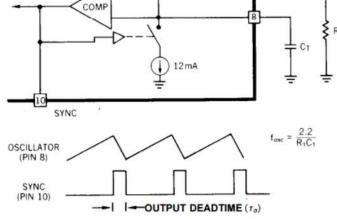


Figure 4. Oscillator Circuit



7.4 Device Functional Modes

7.4.1 Current Limit

One of the most attractive features of a current-mode converter is the ability to limit peak-switch currents on a pulse-by-pulse basis by simply limiting the error voltage to a maximum value.

7.4.2 Shutdown

The shutdown circuit was designed to provide a fast acting general purpose shutdown port for use in implementing both protection circuitry and remote shutdown functions. The circuit may be divided into an input section consisting of a comparator with a 350-mV temperature compensated offset, and an output section consisting of a three transistor latch. Shutdown is accomplished by applying a signal greater than 350 mV to pin 16, causing the output latch to fire, and setting the PWM latch to provide an immediate signal to the outputs.



8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The UCx846/7 family of control devices provides all of the necessary features to implement fixed frequency, current mode control schemes while maintaining a minimum external parts count. The superior performance of this technique can be measured in improved line regulation, enhanced load response characteristics, and a simpler, easier to design control loop. Topological advantages include inherent pulse-by-pulse current limiting capability, automatic symmetry correction for push-pull converters. Protection circuitry includes undervoltage lockout and programmable current limit in addition to soft-start capability. A shutdown function is also available which initiates either a complete shutdown with automatic restart or latch the supply off.

8.2 Typical Application

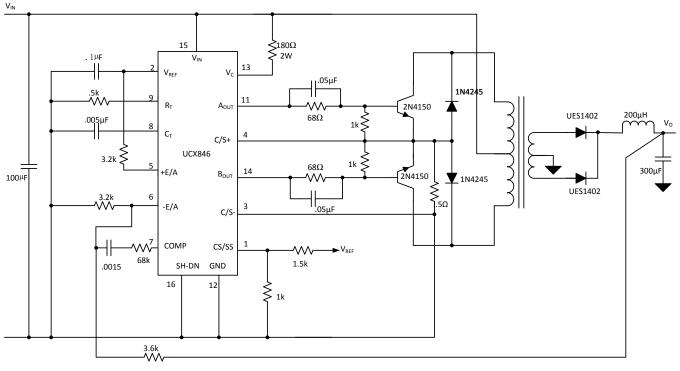


Figure 5. Typical Application Diagram

8.2.1 Design Requirements

Table 1 shows the design parameters for this application.

Table 1. Design Parameters

| DESIGN PARAMETER | TARGET VALUE |
|--|--------------|
| Typical efficiency | 85% |
| Switching frequency | 880 kHz |
| Pulse by pulse current limit threshold | 1 A |

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Product Folder Links: UC1846 UC1847 UC2846 UC2847 UC3846 UC3847

VREF

7) Comp

0.5mA

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8.2.2 Detailed Design Procedure

This section details the design procedure based on the design requirements.

8.2.2.1 Design Switching Frequency

Output deadtime is determined by the external capacitor, C_T, according to the formula:

$$Td(\mu s) = 145 C_{T}(\mu F) \left| \frac{ID}{ID - \frac{3.6}{RT(k\Omega)}} \right|$$

Г

where

• ID = Oscillator discharge current at 25°C; typically is 7.5.

VREF

Zs

5

6

ZF

For large values of R_T : rd (µs) ≈145CT (µF).

Oscillator frequency is approximated by the formula:

$$fT(kHz) \approx \frac{2.2}{(R_T(k\Omega) \times C_T(\mu F))}$$

8.2.2.2 Error Amplifier Output Configuration

Error Amplifier can source up to 0.5mA.

Figure 6. Error Amplifier Output Configuration

IF < 0.5mA

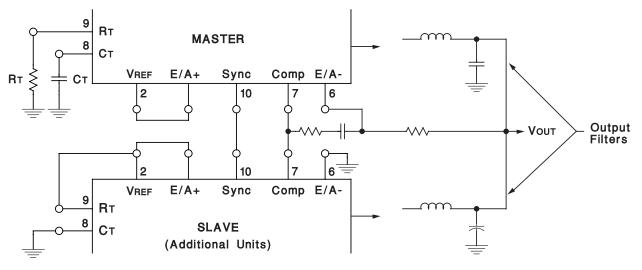
TEXAS INSTRUMENTS

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8.2.2.3 Parallel Operation Configuration



Slaving allows parallel operation of two or more units with equal current sharing.





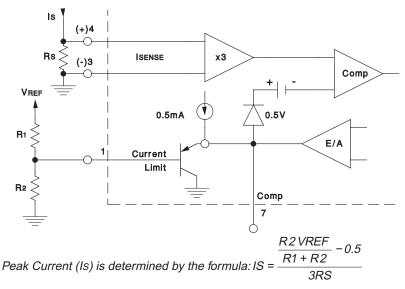
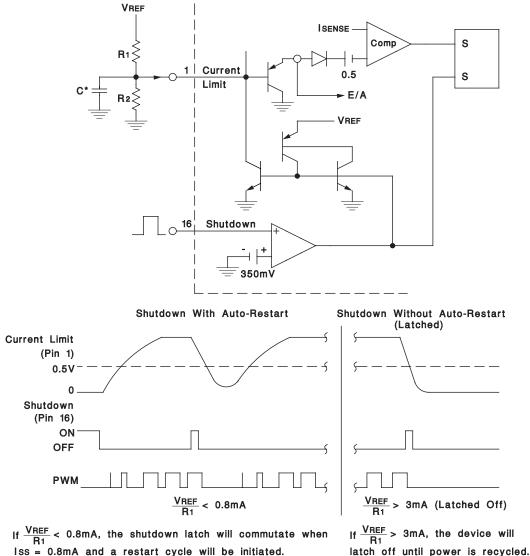


Figure 8. Pulse by Pulse Current Limiting



8.2.2.5 Soft-Start and Shutdown, Restart Function Design

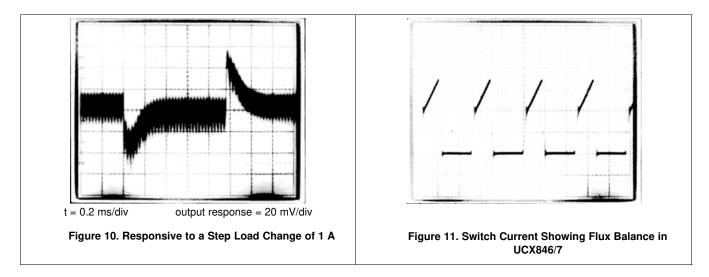


Iss = 0.8mA and a restart cycle will be initiated.

Figure 9. Soft-Start and Shutdown, Restart Functions



8.2.3 Application Curves



9 Power Supply Recommendations

The VIN power terminal for the device requires the placement of low esr noise-decoupling capacitance as directly as possible from the VIN terminal to the GND terminal. Ceramic capacitors with stable dielectric characteristics over temperature are recommended, such as X7R or better.

The VC power terminal for the device requires the placement of resistance as directly as possible from the VC terminal to the VIN terminal.

10 Layout

10.1 Layout Guidelines

- Place a low ESR and ESL decoupling capacitor C_{REF} in the 1-μF to 2.2-μF range, preferably ceramic, from VREF pin to GND.
- The EA+ is a non-inverting input, the EA- is an inverting input and the COMP is the output of the error amplifier. Place resistor and capacitor series network between EA+ pin and COMP pin, and reduce the trace of resistor and capacitor series network as much as possible.
- Place a low ESR and ESL capacitor C_T , preferably ceramic, from CT pin to GND, and place C_T close to UCx846/7 as much as possible.
- Place a resistor R_T from RT pin to GND, and place R_T close to UCx846/7 as much as possible.

10.2 Layout Example

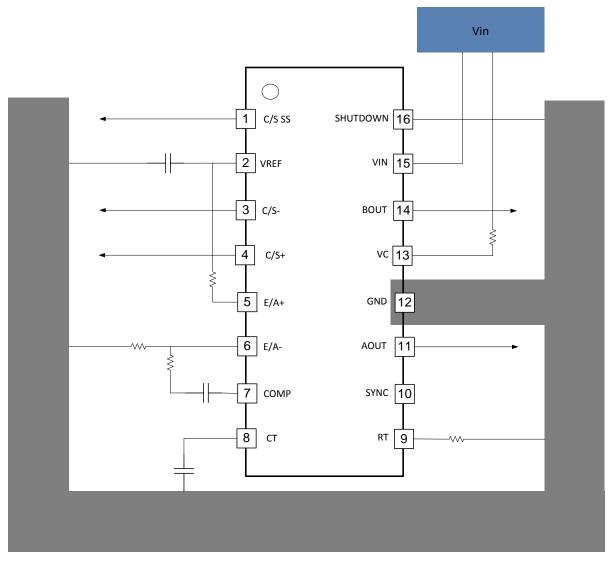


Figure 12. UCx84x Layout Example

Product Folder Links: UC1846 UC1847 UC2846 UC2847 UC3846 UC3847



11 Device and Documentation Support

11.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

| PARTS | PRODUCT FOLDER | SAMPLE & BUY | TECHNICAL DOCUMENTS | TOOLS & SOFTWARE | SUPPORT & COMMUNITY |
|--------|----------------|--------------|------------------------|---------------------|---------------------|
| UC1846 | Click here | Click here | Click here | Click here | Click here |
| UC1847 | Click here | Click here | Click here | Click here | Click here |
| UC2846 | Click here | Click here | Click here | Click here | Click here |
| UC2847 | Click here | Click here | Click here | Click here | Click here |
| UC3846 | Click here | Click here | Click here | Click here | Click here |
| UC3847 | Click here | Click here | Click here | Click here | Click here |

Table 2. Related Links

11.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E[™] Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.3 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

11.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-------------------------|--------------------------------------|----------------------|--------------|--|---------|
| 5962-86806012A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962- 86806012A UC1846L/ 883B | Samples |
| 5962-8680601EA | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8680601EA UC1846J/883B | Samples |
| UC1846J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | UC1846J | Samples |
| UC1846J883B | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Non-Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8680601EA UC1846J/883B | Samples |
| UC1846L883B | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962- 86806012A UC1846L/ 883B | Samples |
| UC2846DW | ACTIVE | SOIC | DW | 16 | 40 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | UC2846DW | Samples |
| UC2846DWG4 | ACTIVE | SOIC | DW | 16 | 40 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | UC2846DW | Samples |
| UC2846DWTR | ACTIVE | SOIC | DW | 16 | 2000 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | UC2846DW | Samples |
| UC2846J | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -40 to 85 | UC2846J | Samples |
| UC2846N | ACTIVE | PDIP | Ν | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -40 to 85 | UC2846N | Samples |
| UC2846NG4 | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -40 to 85 | UC2846N | Samples |
| UC3846DW | ACTIVE | SOIC | DW | 16 | 40 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | 0 to 70 | UC3846DW | Samples |
| UC3846DWTR | ACTIVE | SOIC | DW | 16 | 2000 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | 0 to 70 | UC3846DW | Samples |
| UC3846DWTRG4 | ACTIVE | SOIC | DW | 16 | 2000 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | 0 to 70 | UC3846DW | Samples |
| UC3846N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | UC3846N | Samples |
| UC3846NG4 | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | UC3846N | Samples |
| UC3847DW | ACTIVE | SOIC | DW | 16 | 40 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | 0 to 70 | UC3847DW | Samples |



(1) The marketing status values are defined as follows:
 ACTIVE: Product device recommended for new designs.
 LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
 NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
 PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
 OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF UC1846, UC2846, UC2846M, UC3846 :

• Catalog : UC3846, UC2846

- Enhanced Product : UC1846-EP, UC1846-EP
- Military : UC2846M, UC1846



• Space : UC1846-SP, UC1846-SP

NOTE: Qualified Version Definitions:

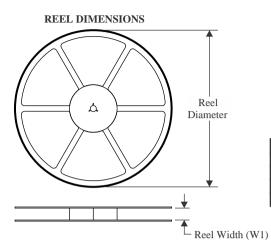
- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

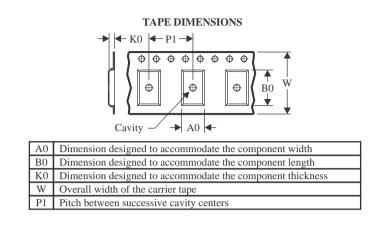


Texas

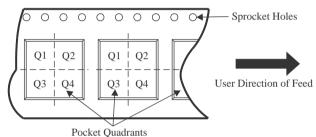
STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

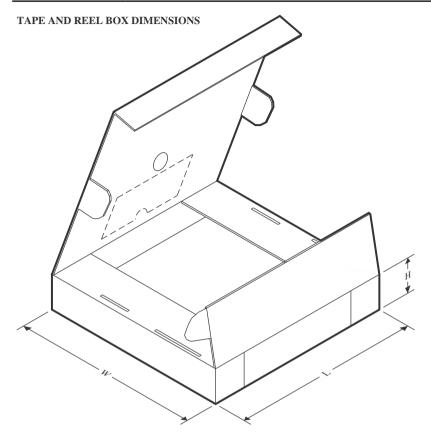


| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| UC2846DWTR | SOIC | DW | 16 | 2000 | 330.0 | 16.4 | 10.75 | 10.7 | 2.7 | 12.0 | 16.0 | Q1 |
| UC3846DWTR | SOIC | DW | 16 | 2000 | 330.0 | 16.4 | 10.75 | 10.7 | 2.7 | 12.0 | 16.0 | Q1 |



PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

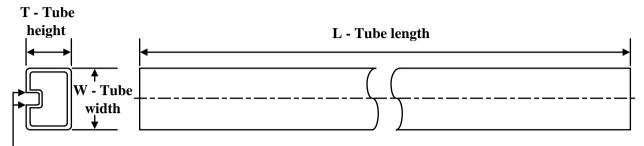
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| UC2846DWTR | SOIC | DW | 16 | 2000 | 356.0 | 356.0 | 35.0 |
| UC3846DWTR | SOIC | DW | 16 | 2000 | 367.0 | 367.0 | 38.0 |

TEXAS INSTRUMENTS

www.ti.com

3-Jun-2022

TUBE



- B - Alignment groove width

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-86806012A | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| UC1846L883B | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| UC2846DW | DW | SOIC | 16 | 40 | 507 | 12.83 | 5080 | 6.6 |
| UC2846DWG4 | DW | SOIC | 16 | 40 | 507 | 12.83 | 5080 | 6.6 |
| UC2846N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| UC2846NG4 | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| UC3846DW | DW | SOIC | 16 | 40 | 507 | 12.83 | 5080 | 6.6 |
| UC3846N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| UC3846NG4 | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| UC3847DW | DW | SOIC | 16 | 40 | 507 | 12.83 | 5080 | 6.6 |

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